DATA SHEET

## NEC

# BIPOLAR ANALOG INTEGRATED CIRCUIT $\mu PC29xxB$ Series

#### THREE-TERMINAL LOW DROPOUT VOLTAGE REGULATOR (OUTPUT CURRENT: 1.0 A)

#### DESCRIPTION

The  $\mu$  PC29xxB series is a series of three-terminal low dropout voltage regulators with 1.0 A output current. This series is suitable for low voltage operated IC and has 4 output voltage types, 1.8 V, 2.5 V, 3.3 V and 5.0 V. Compared with the  $\mu$  PC29xx and  $\mu$  PC29xxA series, this series has improved output voltage tolerance (Vo ± 2%), quiescent current (1.8 mA TYP. (Io = 0 A)), and short-circuit current.

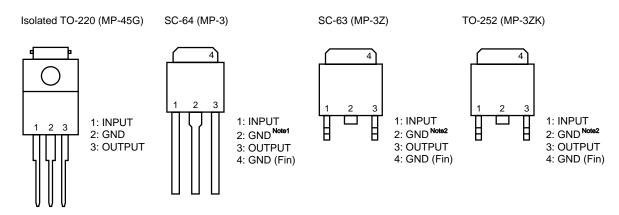
#### FEATURES

- Output current capacity: 1.0 A
- Output voltage tolerance: Vo  $\pm$  2% (TA = 25°C)
- Low quiescent current: 1.8 mA TYP. (Io = 0 A)
- Low short-circuit current: 0.3 A TYP. (μPC2918B), 0.6 A TYP. (μPC2925B, μPC2933B), 0.65 A TYP. (μPC2905B)
- Low dropout voltage: VDIF = 0.6 V MAX. (Io = 0.5 A)
- On-chip inrush current protection circuit at the time of input voltage rising (when input voltage is low)
- On-chip over-current limiter
- On-chip thermal shut down circuit

#### APPLICATIONS

Digital TV, DVD, LCD Monitors, Printers, Audio, Air Conditioners, and other applications.

#### PIN CONFIGURATIONS (Marking Side)



Notes 1. No.2 pin and No.4 fin are common GND.

2. No.2 pin is cut. No.2 pin and No.4 fin are common GND.

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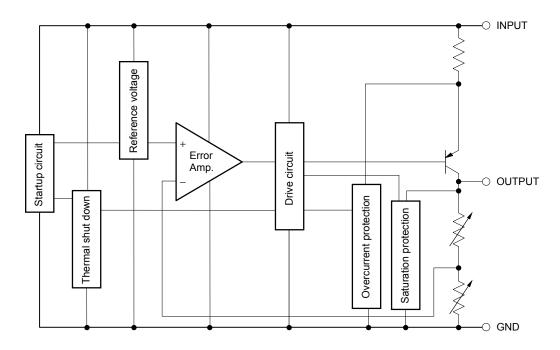
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The mark <R> shows major revised points.

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The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what:" field.

#### **BLOCK DIAGRAM**



#### <R> ORDERING INFORMATION

Part Number	Package	Output Voltage	Marking
μPC2918BHF	Isolated TO-220 (MP-45G)	1.8 V	2918B
μPC2918BHB	SC-64 (MP-3)	1.8 V	2918B
μPC2918BT	SC-63 (MP-3Z)	1.8 V	2918B
μPC2918BT1D	TO-252 (MP-3ZK)	1.8 V	2918BD
μPC2925BHF	Isolated TO-220 (MP-45G)	2.5 V	2925B
μPC2925BHB	SC-64 (MP-3)	2.5 V	2925B
μPC2925BT	SC-63 (MP-3Z)	2.5 V	2925B
μPC2925BT1D	TO-252 (MP-3ZK)	2.5 V	2925BD
μPC2933BHF	Isolated TO-220 (MP-45G)	3.3 V	2933B
μPC2933BHB	SC-64 (MP-3)	3.3 V	2933B
μPC2933BT	SC-63 (MP-3Z)	3.3 V	2933B
μPC2933BT1D	TO-252 (MP-3ZK)	3.3 V	2933BD
μPC2905BHF	Isolated TO-220 (MP-45G)	5.0 V	2905B
μPC2905BHB	SC-64 (MP-3)	5.0 V	2905B
μPC2905BT	SC-63 (MP-3Z)	5.0 V	2905B
μPC2905BT1D	TO-252 (MP-3ZK)	5.0 V	2905BD

**Remark** Tape-packaged products have the symbol -E1, or -E2 suffixed to the part number. In Pb-free products, any of -AT, -AZ or -AY is added to the end of their part number. Refer to the following table for details.

Part Number Note1	Package	Package Type
μPC29xxBHF	Isolated TO-220 (MP-45G)	Packed in envelop
µPC29xxBHF-AZ	Isolated TO-220 (MP-45G)	Packed in envelop
μPC29xxBHB	SC-64 (MP-3)	Packed in envelop
μPC29xxBHB-AZ <sup>Note2</sup>	SC-64 (MP-3)	Packed in envelop
μPC29xxBHB-AY <sup>Note3</sup>	SC-64 (MP-3)	Packed in envelop
μPC29xxBT	SC-63 (MP-3Z)	Packed in envelop
μPC29xxBT-AZ Note2	SC-63 (MP-3Z)	Packed in envelop
μPC29xxBT-E1	SC-63 (MP-3Z)	<ul> <li>16 mm wide embossed taping</li> </ul>
		Pin 1 on draw-out side
		2000 pcs/reel
μPC29xxBT-E1-AZ <sup>Note2</sup>	SC-63 (MP-3Z)	<ul> <li>16 mm wide embossed taping</li> </ul>
		Pin 1 on draw-out side
		• 2000 pcs/reel
μPC29xxBT-E1-AY <sup>Note3</sup>	SC-63 (MP-3Z)	<ul> <li>16 mm wide embossed taping</li> </ul>
		Pin 1 on draw-out side
		• 2000 pcs/reel
μPC29xxBT-E2	SC-63 (MP-3Z)	<ul> <li>16 mm wide embossed taping</li> </ul>
		Pin 1 at take-up side
		• 2000 pcs/reel
µPC29xxBT-E2-AZ <sup>Note2</sup>	SC-63 (MP-3Z)	<ul> <li>16 mm wide embossed taping</li> </ul>
		<ul> <li>Pin 1 at take-up side</li> </ul>
		• 2000 pcs/reel
μPC29xxBT-E2-AΥ <sup>Note3</sup>	SC-63 (MP-3Z)	<ul> <li>16 mm wide embossed taping</li> </ul>
		<ul> <li>Pin 1 at take-up side</li> </ul>
		• 2000 pcs/reel
μPC29xxBT1D-E1	TO-252 (MP-3ZK)	<ul> <li>16 mm wide embossed taping</li> </ul>
		Pin 1 on draw-out side
		• 2500 pcs/reel
μPC29xxBT1D-E1-AT <sup>Note4</sup>	TO-252 (MP-3ZK)	<ul> <li>16 mm wide embossed taping</li> </ul>
		Pin 1 on draw-out side
		• 2500 pcs/reel
$\mu$ PC29xxBT1D-E2	TO-252 (MP-3ZK)	16 mm wide embossed taping
		Pin 1 at take-up side
Notod		2500 pcs/reel
μPC29xxBT1D-E2-AT <sup>Note4</sup>	TO-252 (MP-3ZK)	<ul> <li>16 mm wide embossed taping</li> </ul>
		Pin 1 at take-up side
		2500 pcs/reel

**Notes 1.** xx stands for symbols that indicate the output voltage.

2. Pb-free (This product does not contain Pb in the external electrode.)

3. Pb-free (This product does not contain Pb in the external electrode, Sn100% plating.)

4. Pb-free (This product does not contain Pb in the external electrode and other parts.)

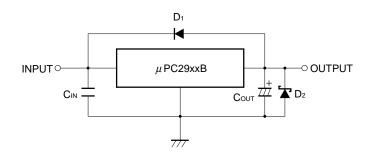
Parameter Symbol		Rat	Unit	
		μPC29xxBHF	μPC29xxBHB, μPC29xxBT, μPC29xxBT1D	
Input Voltage VIN		-0.3 to +16.0		V
Internal Power Dissipation (Tc = $25^{\circ}$ C) <sup>Note</sup>	P⊤	15	10	W
Operating Ambient Temperature	TA	–40 t	°C	
Operating Junction Temperature	ТJ	–40 tc	°C	
Storage Temperature	Tstg	-55 to +150		°C
Thermal Resistance (junction to case)	Rth(J-C)	7	12.5	°C/W
Thermal Resistance (junction to ambient) Rth(		65	125	°C/W

#### ABSOLUTE MAXIMUM RATINGS (TA = 25°C, unless otherwise specified)

**Note** Internally limited. When the operating junction temperature rises above 150°C, the internal circuit shuts down the output voltage.

Caution Product quality may suffer if the absolute maximum rating is exceeded even momentarily for any parameter. That is, the absolute maximum ratings are rated values at which the product is on the verge of suffering physical damage, and therefore the product must be used under conditions that ensure that the absolute maximum ratings are not exceeded.

#### TYPICAL CONNECTION



- $C_{IN}$ : 0.1  $\mu$ F or higher. Be sure to connect  $C_{IN}$  to prevent parasitic oscillation. Set this value according to the length of the line between the regulator and the INPUT pin. Use of a film capacitor or other capacitor with first-rate voltage and temperature characteristics is recommended. If using a laminated ceramic capacitor, it is necessary to ensure that  $C_{IN}$  is 0.1  $\mu$ F or higher for the voltage and temperature range to be used.
- Cout: 10 μF or higher. Be sure to connect Cout to prevent oscillation and improve excessive load regulation. Place CIN and Cout as close as possible to the IC pins (within 1 to 2 cm). Also, use an electrolytic capacitor with low impedance characteristics if considering use at sub-zero temperatures.
- $\mathsf{D}_1$  : If the OUTPUT pin has a higher voltage than the INPUT pin, connect a diode.
- D<sub>2</sub> : If the OUTPUT pin has a lower voltage than the GND pin, connect a Schottky barrier diode.

#### Caution Make sure that no voltage is applied to the OUTPUT pin from external.

#### RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Type Number	MIN.	TYP.	MAX.	Unit
Input Voltage	VIN	μPC2918B	2.8		12.0	V
		μPC2925B	3.5		12.0	V
		μPC2933B	4.3		12.0	V
		μPC2905B	6.0		12.0	V
Output Current	lo	All	0		1.0	А
Operating Ambient Temperature	TA	All	-40		+85	°C
Operating Junction Temperature	TJ	All	-40		+ 125	°C

Caution Use of conditions exceeding the above-listed recommended operating conditions is not a problem as long as the absolute maximum ratings are not exceeded. However, since the use of such conditions diminishes the margin of safety, careful evaluation is required before such conditions are used.

#### **ELECTRICAL CHARACTERISTICS**

#### $\mu$ PC2918B (T<sub>J</sub> = 25°C, V<sub>IN</sub> = 2.8 V, Io = 0.5 A, C<sub>IN</sub> = 0.1 $\mu$ F, Cout = 10 $\mu$ F, unless otherwise specified)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Output Voltage	V <sub>01</sub>		1.764	1.8	1.836	V
	V <sub>02</sub>	$2.8 \text{ V} \leq V_{\text{IN}} \leq 12 \text{ V}, \text{ 0 A} \leq I_{\text{O}} \leq 1 \text{ A}$	(1.746)	_	(1.854)	V
Line Regulation	REGIN	$2.8~V \leq V_{IN} \leq 12~V$	_	4.0	25.0	mV
Load Regulation	REG∟	$0 A \le I_0 \le 1 A$	-	3.5	30.0	mV
Quiescent Current	BIAS	Io = 0 A	_	1.8	4.0	mA
		lo = 0.5 A	-	18.0	(30.0)	mA
Startup Quiescent Current	BIAS(S)	V <sub>IN</sub> = 1.7 V, Io = 0 A	_	1.0	30.0	mA
		V <sub>IN</sub> = 2.4 V, Io = 1 A	_	_	(80.0)	mA
Quiescent Current Change	⊿Ibias	$2.8~V \leq V_{IN} \leq 12~V$	-	(3.0)	(15.0)	mA
Output Noise Voltage	Vn	10 Hz ≤ f ≤ 100 kHz	_	50.0	_	$\mu V_{r.m.s.}$
Ripple Rejection	R•R	f = 120 Hz, 2.8 V $\leq$ V $_{\rm IN}$ $\leq$ 3.8 V, Io = 0.3 A	_	62	_	dB
Dropout Voltage	VDIF	lo = 0.5 A	_	0.3	0.6	V
		Io = 1 A	_	(0.7)	_	V
Short Circuit Current	lOshort	V <sub>IN</sub> = 2.8 V	(0.1)	0.3	(0.8)	А
		V <sub>IN</sub> = 12 V	-	(0.4)	-	А
Peak Output Current	Opeak	V <sub>IN</sub> = 2.8 V	1.0	1.3	(1.6)	Α
		V <sub>IN</sub> = 12 V	-	(1.1)	-	А
Temperature Coefficient of Output Voltage	⊿Vo/⊿T	$0^{\circ}C \leq T_{J} \leq 125^{\circ}C, \ Io = 5 \ mA$	_	0.1	_	mV/°C

Remark Values in parentheses are product design values, and are thus provided as reference values.

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Output Voltage	V <sub>01</sub>		2.45	2.5	2.55	V
	V <sub>02</sub>	$3.5 \text{ V} \leq V_{\text{IN}} \leq 12 \text{ V}, 0 \text{ A} \leq \text{Io} \leq 1 \text{ A}$	(2.425)	_	(2.575)	V
Line Regulation	REGIN	$3.5~V \leq V_{\text{IN}} \leq 12~V$	_	5.5	25.0	mV
Load Regulation	REG∟	$0 A \le I_0 \le 1 A$	-	3.5	40.0	mV
Quiescent Current	BIAS	Io = 0 A	-	1.8	4.0	mA
		lo = 0.5 A	_	18.0	(30.0)	mA
Startup Quiescent Current	BIAS(S)	V <sub>IN</sub> = 2.4 V, Io = 0 A	-	11.0	30.0	mA
		V <sub>IN</sub> = 3.1 V, Io = 1 A	-	_	(80.0)	mA
Quiescent Current Change	⊿Ibias	$3.5~V \leq V_{\text{IN}} \leq 12~V$	_	(3.0)	(15.0)	mA
Output Noise Voltage	Vn	10 Hz ≤ f ≤ 100 kHz	-	62.0	-	μVr.m.s.
Ripple Rejection	R•R	f = 120 Hz, 3.5 V $\leq$ VIN $\leq$ 4.5 V, Io = 0.3 A	-	60	-	dB
Dropout Voltage	VDIF	Io = 0.5 A	-	0.36	0.6	V
		lo = 1 A	-	(0.7)	-	V
Short Circuit Current	lOshort	V <sub>IN</sub> = 3.5 V	(0.1)	0.6	(0.8)	А
		V <sub>IN</sub> = 12 V	-	(0.4)	_	А
Peak Output Current	lOpeak	V <sub>IN</sub> = 3.5 V	1.0	1.3	(1.6)	А
		V <sub>IN</sub> = 12 V	-	(1.1)	_	А
Temperature Coefficient of Output Voltage	⊿Vo/⊿T	$0^{\circ}C \leq T_{\rm J} \leq 125^{\circ}C, \ lo = 5 \ mA$	-	0.2	-	mV/°C

11 PC2925B	$T_1 = 25^{\circ}C$	$V_{IN} = 3.5 V$		$= 0.1 \mu E Co$	$uT = 10 \mu F unk$	ess otherwise sp	ocified)
$\mu$ F CZ9Z9D	13 - 25  C	, VIN – 3.5 V, I	0 - 0.5 A, CIN	$1 - 0.1 \mu$ F, CO	$\mu$	335 Uliiei wise sp	Jecilieu)

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**Remark** Values in parentheses are product design values, and are thus provided as reference values.

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Output Voltage	V <sub>01</sub>		3.234	3.3	3.366	V
	V <sub>02</sub>	$4.3 \text{ V} \leq V_{\text{IN}} \leq 12 \text{ V}, 0 \text{ A} \leq I_{\text{O}} \leq 1 \text{ A}$	(3.201)	_	(3.399)	V
Line Regulation	REGIN	$4.3~V \le V_{IN} \le 12~V$	_	6.0	25.0	mV
Load Regulation	REG∟	$0 A \le I_0 \le 1 A$	_	4.2	50.0	mV
Quiescent Current	IBIAS	Io = 0 A	_	1.8	4.0	mA
		lo = 0.5 A	-	18.0	(30.0)	mA
Startup Quiescent Current	IBIAS(S)	V <sub>IN</sub> = 3.1 V, I <sub>O</sub> = 0 A	_	11.0	30.0	mA
		V <sub>IN</sub> = 3.7 V, Io = 1 A	_	_	(80.0)	mA
Quiescent Current Change	⊿Ibias	$4.3~V \le V_{IN} \le 12~V$	-	(3.0)	(15.0)	mA
Output Noise Voltage	Vn	10 Hz ≤ f ≤ 100 kHz	-	82.0	_	$\mu V_{r.m.s.}$
Ripple Rejection	R•R	f = 120 Hz, 4.3 V $\leq$ VIN $\leq$ 5.3 V, Io = 0.3 A	-	58	-	dB
Dropout Voltage	VDIF	Io = 0.5 A	-	0.36	0.6	V
		lo = 1 A	-	(0.7)	_	V
Short Circuit Current	lOshort	V <sub>IN</sub> = 5.0 V	(0.1)	0.6	(0.8)	А
		V <sub>IN</sub> = 12 V	_	(0.4)	_	А
Peak Output Current	lOpeak	V <sub>IN</sub> = 5.0 V	1.0	1.5	(1.6)	А
		V <sub>IN</sub> = 12 V	_	(1.1)	_	А
Temperature Coefficient of Output Voltage	⊿Vo/⊿T	$0^{\circ}C \leq T_{\rm J} \leq 125^{\circ}C, \ I_{\rm O} = 5 \ mA$	_	0.4	_	mV/°C

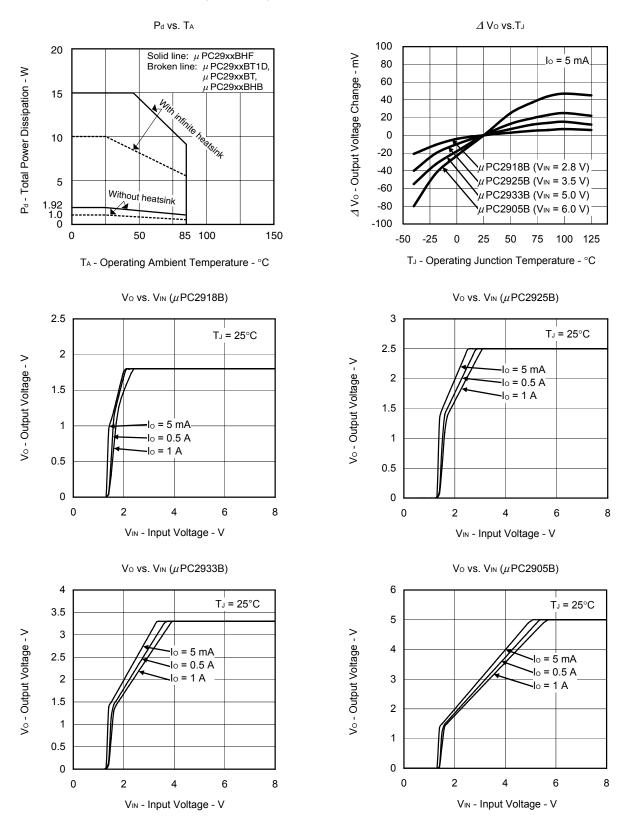
Remark Values in parentheses are product design values, and are thus provided as reference values.

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Output Voltage	V <sub>01</sub>		4.90	5.0	5.10	V
	V <sub>02</sub>	$6.0 \text{ V} \leq V_{\text{IN}} \leq 12 \text{ V}, \text{ 0 A} \leq I_0 \leq 1 \text{ A}$	(4.85)	_	(5.15)	V
Line Regulation	REGIN	$6.0 \ V \leq V_{IN} \leq 12 \ V$	-	6.5	25.0	mV
Load Regulation	REG∟	$0 A \le I_0 \le 1 A$	-	5.0	80.0	mV
Quiescent Current	BIAS	Io = 0 A	-	1.8	4.0	mA
		lo = 0.5 A	-	18.0	(30.0)	mA
Startup Quiescent Current	BIAS(S)	V <sub>IN</sub> = 4.8 V, I <sub>O</sub> = 0 A	-	11.0	30.0	mA
		V <sub>IN</sub> = 5.5 V, Io = 1 A	-	_	(80.0)	mA
Quiescent Current Change	∕IBIAS	$6.0~V \leq V_{IN} \leq 12~V$	-	(3.0)	(15.0)	mA
Output Noise Voltage	Vn	10 Hz $\leq$ f $\leq$ 100 kHz	-	122.0	-	μVr.m.s.
Ripple Rejection	R•R	f = 120 Hz, 6.0 V $\leq$ VIN $\leq$ 7 V, Io = 0.3 A	-	57	_	dB
Dropout Voltage	VDIF	lo = 0.5 A	-	0.38	0.6	V
		lo = 1 A	-	(0.7)	_	V
Short Circuit Current	lOshort	V <sub>IN</sub> = 6.5 V	(0.1)	0.65	(0.8)	А
		V <sub>IN</sub> = 12 V	-	(0.4)	-	А
Peak Output Current	lOpeak	V <sub>IN</sub> = 6.5 V	1.0	1.5	(1.6)	А
		V <sub>IN</sub> = 12 V	-	(1.1)	_	А
Temperature Coefficient of Output Voltage	⊿Vo/⊿T	$0^{\circ}C \leq T_{J} \leq 125^{\circ}C, \ Io = 5 \ mA$	_	0.6	_	mV/°C

// PC2905B (	$T_1 = 25^{\circ}C_2$	$V_{IN} = 6.0 V_{.}I_{.}$	0 = 0.5 A. CIN = 0.1	//F. COUT = 10	$\mu$ F, unless otherwise	specified)
$\mu$ 1 02000 U	(13 - 20 0)	, wiis — 0.0 v, i	0 - 0.0 R, 0 R - 0.1	$\mu_1, 0001 - 10$	$\mu$ 1, unicos ounci wisc	specificaj

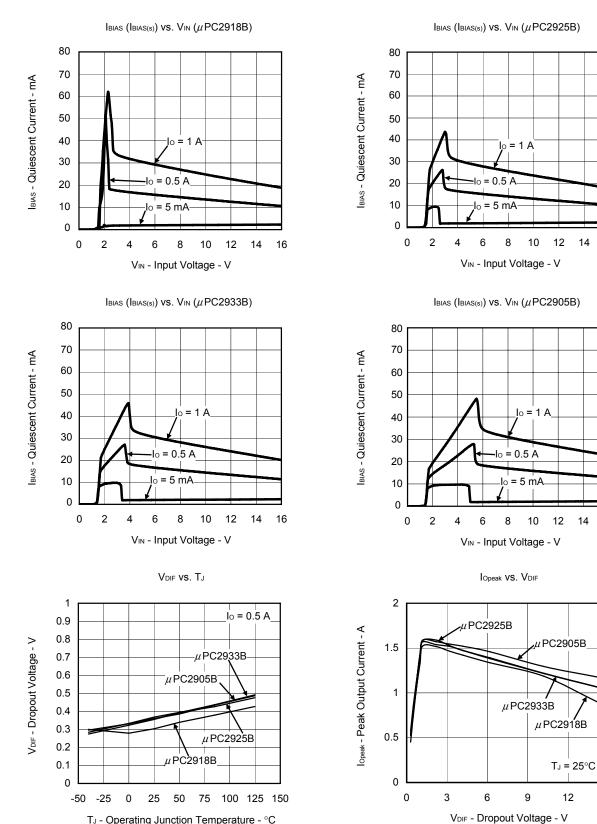
**Remark** Values in parentheses are product design values, and are thus provided as reference values.

#### TYPICAL CHARACTERISTICS (T<sub>A</sub> = 25°C)



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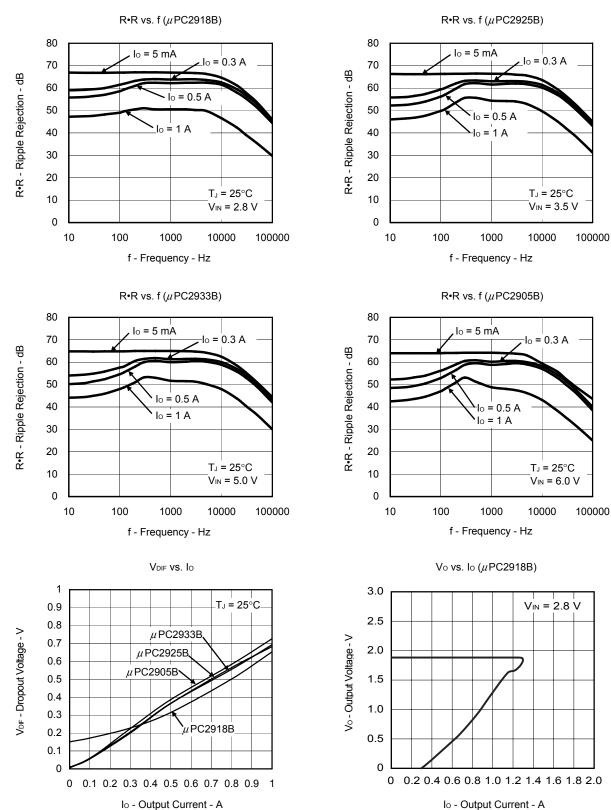


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TJ - Operating Junction Temperature - °C

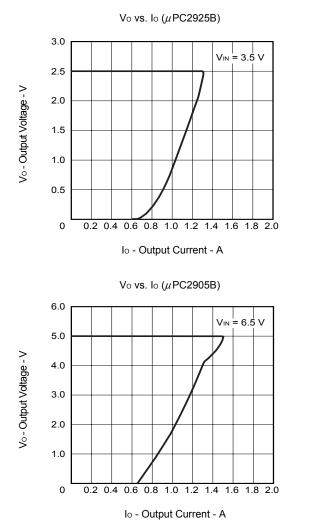
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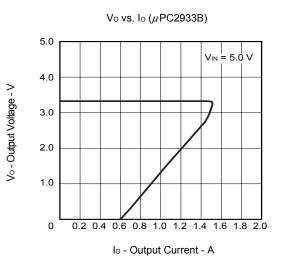
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lo - Output Current - A

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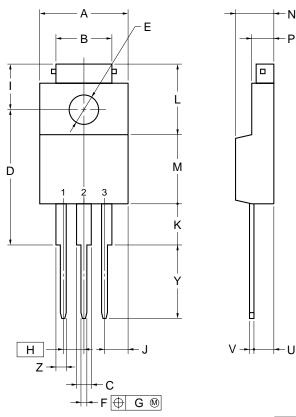
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#### PACKAGE DRAWINGS (Unit: mm)

 $\mu$  PC2918BHF,  $\mu$  PC2925BHF,  $\mu$  PC2933BHF,  $\mu$  PC2905BHF

#### **3PIN PLASTIC SIP (MP-45G)**



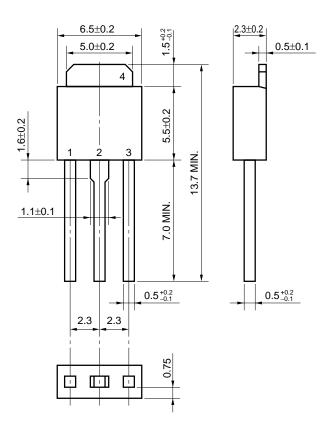
#### NOTE

Each lead centerline is located within 0.25 mm of its true position (T.P.) at maximum material condition.

ITEM	MILLIMETERS
Α	10.0±0.2
В	7.0±0.2
С	1.50±0.2
D	17.0±0.3
Е	φ3.3±0.2
F	0.75±0.10
G	0.25
Н	2.54 (T.P.)
I	5.0±0.3
J	2.46±0.2
К	5.0±0.2
L	8.5±0.2
М	8.5±0.2
Ν	4.5±0.2
Р	2.8±0.2
U	2.4±0.5
V	0.65±0.10
Y	8.9±0.7
Z	1.30±0.2
	P3HF-254B-4

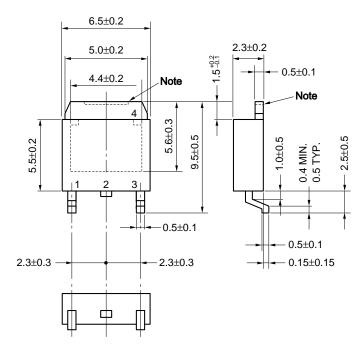
#### $\mu$ PC2918BHB, $\mu$ PC2925BHB, $\mu$ PC2933BHB, $\mu$ PC2905BHB

#### SC-64 (MP-3)



#### $\mu$ PC2918BT, $\mu$ PC2925BT, $\mu$ PC2933BT, $\mu$ PC2905BT

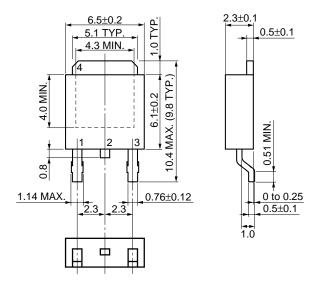
#### <R> SC-63 (MP-3Z) (Unit: mm)



Note The depth of notch at the top of the fin is from 0 to 0.2 mm.

#### $\mu$ PC2918BT1D, $\mu$ PC2925BT1D, $\mu$ PC2933BT1D, $\mu$ PC2905BT1D

#### TO-252 (MP-3ZK)



### NEC

#### <R> RECOMMENDED MOUNTING CONDITIONS

The  $\mu$ PC29xxB Series should be soldered and mounted under the following recommended conditions.

For soldering methods and conditions other than those recommended below, contact an NEC Electronics sales representative.

For technical information, see the following website.

#### Semiconductor Device Mount Manual (http://www.necel.com/pkg/en/mount/index.html)

#### **Surface Mount Device**

$\mu$ PC29XXBT1D Series: 10-252 (MP-32K)			
Process	Conditions	Symbol	
Infrared Ray Reflow	Peak temperature: 260°C or below (Package surface temperature), Reflow time: 60 seconds or less (at 220°C or higher), Maximum number of reflow processes: 3 times or less.	IR60-00-3	
Vapor Phase Soldering	Peak temperature: 215°C or below (Package surface temperature), Reflow time: 40 seconds or less (at 200°C or higher), Maximum number of reflow processes: 3 times or less.	VP15-00-3	
Partial Heating Method	Pin temperature: 350°C or below, Heat time: 3 seconds or less (Per each side of the device).	P350	

#### μ PC29xxBT Series: SC-63 (MP-3Z) μ PC29xxBT1D Series: TO-252 (MP-3ZK)

## μ PC29xxBT-AZ Series <sup>Note1</sup>, μ PC29xxBT-AY Series <sup>Note2</sup>: SC-63 (MP-3Z)

 $\mu$  PC29xxBT1D-AT Series <sup>Note3</sup>: TO-252 (MP-3ZK)

Process	Conditions	Symbol
Infrared Ray Reflow	Peak temperature: 260°C or below (package surface temperature),	IR60-00-3
	Reflow time: 60 seconds or less (at 220°C or higher),	
	Maximum number of reflows processes: 3 times or less.	
Partial Heating Method	Pin temperature: 350°C or below,	P350
	Heat time: 3 seconds or less (per each side of the device).	

Notes 1. Pb-free (This product does not contain Pb in the external electrode.)

2. Pb-free (This product does not contain Pb in the external electrode, Sn100% plating.)

3. Pb-free (This product does not contain Pb in the external electrode and other parts.)

## Caution Apply only one kind of soldering condition to a device, except for "partial heating method", or the device will be damaged by heat stress.

Remark Flux: Rosin-based flux with low chlorine content (chlorine 0.2 Wt% or below) is recommended.

#### Type of Through-hole Device

#### $\mu$ PC29xxBHF Series, $\mu$ PC29xxBHF-AZ Series <sup>Note1</sup>: Isolated TO-220 (MP-45G)

## μPC29xxBHB Series, μPC29xxBHB-AZ Series<sup>Note1</sup>, μPC29xxBHB-AY Series<sup>Note2</sup>: SC-64 (MP-3)

Process	Conditions	Symbol
Wave Soldering	Solder temperature: 260°C or below, Flow time: 10 seconds or less	WS60-00-1
(only to leads)		
Partial Heating Method	Pin temperature: 350°C or below, Heat time: 3 seconds or less (per each pin).	P350

Notes 1. Pb-free (This product does not contain Pb in the external electrode.)

2. Pb-free (This product does not contain Pb in the external electrode, Sn100% plating.)

Caution For through-hole device, the wave soldering process must be applied only to leads, and make sure that the package body does not get jet soldered.

#### **REFERENCE DOCUMENTS**

	USER'S MANUAL USAGE OF THREE TERMINAL REGULATORS	Document No.G12702E
<r></r>	REVIEW OF QUALITY AND RELIABILITY HANDBOOK	Document No.C12769E
	INFORMATION VOLTAGE REGULATOR OF SMD	Document No.G11872E
	SEMICONDUCTOR DEVICE MOUNT MANUAL	http://www.necel.com/pkg/en/mount/index.html

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